

# SPECIFICATION

(Reference sheet)

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor

- Samsung P/N : **CL21C102JCFNNG**
- Description : **CAP, 1nF, 100V, ± 5%, COG, 0805**

## A. Samsung Part Number

**CL** **21** **C** **102** **J** **C** **F** **N** **N** **N** **G**  
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

|                                |                                       |                          |                         |  |
|--------------------------------|---------------------------------------|--------------------------|-------------------------|--|
| ① <b>Series</b>                | Samsung Multi-layer Ceramic Capacitor |                          |                         |  |
| ② <b>Size</b>                  | 0805 (inch code)                      | L: 2.00 ± 0.10 mm        | W: 1.25 ± 0.10 mm       |  |
| ③ <b>Dielectric</b>            | COG                                   | ⑧ <b>Inner electrode</b> | Ni                      |  |
| ④ <b>Capacitance</b>           | 1 nF                                  | <b>Termination</b>       | Cu                      |  |
| ⑤ <b>Capacitance tolerance</b> | ± 5%                                  | <b>Plating</b>           | Sn 100% (Pb Free)       |  |
| ⑥ <b>Rated Voltage</b>         | 100 V                                 | ⑨ <b>Product</b>         | Normal                  |  |
| ⑦ <b>Thickness</b>             | 1.25 ± 0.10 mm                        | ⑩ <b>Special</b>         | Reserved for future use |  |
|                                |                                       | ⑪ <b>Packaging</b>       | Embossed Type, 7" reel  |  |

## B. Structure and dimension



| Samsung P/N<br>(Lead Free) | Dimension(mm) |             |             |                 |
|----------------------------|---------------|-------------|-------------|-----------------|
|                            | L             | W           | T           | BW              |
| CL21C102JCFNNG             | 2.00 ± 0.10   | 1.25 ± 0.10 | 1.25 ± 0.10 | 0.50+0.20/-0.30 |

### C. Samsung Reliability Test and Judgement condition

|                                  | Performance  | Test condition  |
|----------------------------------|--|---|
| Capacitance                      | Within specified tolerance   | 1MHz±10% / 0.5~5Vrms  |
| Q                                | 1,000 min  |   |
| Insulation Resistance            | 10,000Mohm or 500Mohm× $\mu$ F<br>Whichever is smaller   | Rated Voltage 60~120 sec.   |
| Appearance                       | No abnormal exterior appearance  | Microscop (X10)   |
| Withstanding Voltage             | No dielectric breakdown or mechanical breakdown  | 200% of the rated voltage   |
| Temperature Characteristics      | COG<br>(From -55℃ to 125℃, Capacitance change should be within ±30PPM/℃)   |   |
| Adhesive Strength of Termination | No peeling shall be occur on the terminal electrode  | 500g×F, for 10±1 sec.   |
| Bending Strength                 | Capacitance change :<br>within ±5% or ±0.5pF whichever is larger   | Bending to the limit (1mm)<br>with 1.0mm/sec.   |
| Solderability                    | More than 75% of terminal surface is to be soldered newly  | SnAg3.0Cu0.5 solder<br>245±5℃, 3±0.3sec.<br>(preheating : 80~120℃ for 10~30sec.)                                |
| Resistance to Soldering heat     | Capacitance change :<br>within ±2.5% or ±0.25pF whichever is larger<br>Tan $\delta$ , IR : initial spec.                                       | Solder pot : 270±5℃, 10±1sec.   |
| Vibration Test                   | Capacitance change :<br>within ±2.5% or ±0.25pF whichever is larger<br>Tan $\delta$ , IR : initial spec.                                       | Amplitude : 1.5mm<br>From 10Hz to 55Hz (return : 1min.)<br>2hours ´ 3 direction (x, y, z)                       |
| Moisture Resistance              | Capacitance change :<br>within ±7.5% or ±0.75pF whichever is larger<br>Q : 200 min<br>IR : 500Mohm or 25Mohm × $\mu$ F<br>Whichever is smaller | With rated voltage<br>40±2℃, 90~95%RH, 500+12/-0hrs   |
| High Temperature Resistance      | Capacitance change :<br>within ±3% or ±0.3pF whichever is larger<br>Q : 350 min<br>IR : 1,000Mohm or 50Mohm × $\mu$ F<br>Whichever is smaller  | With 200% of the rated voltage<br>Max. operating temperature<br>1000+48/-0hrs                                   |
| Temperature Cycling              | Capacitance change :<br>within ±2.5% or ±0.25pF whichever is larger<br>Tan $\delta$ , IR : initial spec.                                       | 1 cycle condition<br>Min. operating temperature → 25℃<br>→ Max. operating temperature → 25℃<br><br>5 cycle test |

※ The reliability test condition can be replaced by the corresponding accelerated test condition.

### D. Recommended Soldering method :

Reflow ( Reflow Peak Temperature : 260+0/-5℃, 10sec. Max )

 Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

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